

STS5NF60L

N-channel 60V - 0.045Ω - 5A - SO-8 STripFET™ Power MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D
STS5NF60L	60V	<0.055Ω	5A

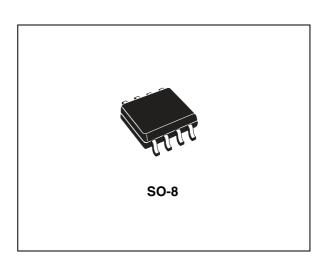
- Standard outline for easy automated surface mount assembly
- Low threshold drive

Description

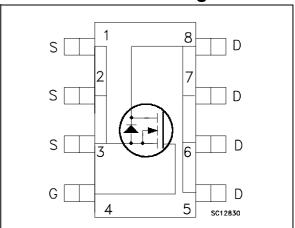
This Power MOSFET is the latest development of STMicroelectronis unique "Single Feature SizeTM" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

Applications

Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging	
STS5NF60L	S5NF60L	SO-8	Tape&reel	

Contents STS5NF60L

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STS5NF60L Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (v _{gs} = 0)	60	V
V _{GS}	Gate- source voltage	±20	V
I _D	Drain current (continuous) at T _C = 25°C	5	Α
I _D	Drain current (continuous) at T _C = 100°C	3	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	20	Α
P _{TOT}	Total dissipation at T _C = 25°C	2.5	W
	Derating factor	0.02	W/°C
dv/dt (2)	Peak diode recovery voltage slope	5.5	V/ns
T _{stg} T _j	Storage Temperature Max operating junction temperature	-55 to 150 150	°C °C

^{1.} Pulse width limited by safe operating area

Table 2. Thermal data

R_{thj-a}	⁽¹⁾ Thermal resistance junction-ambient Max	50	°C/W
T _I	Maximum lead temperature for soldering purpose Typ	150	ů

^{1.} Mounted on FR-4 board (t 10 sec.).

 $^{2. \}quad I_{SD} \leq \!\! 5A, \, di/dt \leq \!\! 100A/\mu s, \, V_{DD} \leq \!\! V_{(BR)DSS}, \, T_j \leq \!\! T_{JMAX}$

Electrical characteristics STS5NF60L

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	60			V
I _{DSS}	Zero gate voltage Drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} = Max rating, T_{C} =125°C			1 10	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.7	2.5	V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10V, I_D = 2.5A$ $V_{GS} = 4.5V, I_D = 2.5A$		0.045 0.050	0.055 0.065	Ω

Table 4. Dynamic

	<u> </u>					
Symbol	Parameter	Parameter Test conditions Min.		Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15V, I _D =2.5 A		7		S
C _{iss}	Input capacitance			1250		pF
C_{oss}	Output capacitance	$V_{DS} = 25V, f = 1 \text{ MHz},$		130		pF
C_{rss}	Reverse transfer capacitance	V _{GS} = 0		26		pF
Qg	Total gate charge	$V_{DD} = 48V, I_D = 5A,$		17		nC
Q_{gs}	Gate-source charge	$V_{DD} = 48V$, $I_D = 5A$, $V_{GS} = 5V$		4.5		nC
Q_{gd}	Gate-drain charge	(see Figure 13)		6		nC

^{1.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5.

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	V_{DD} =30 V, I_{D} =2.5A, R_{G} =4.7 Ω , V_{GS} =4.5V (see Figure 12)		13 28		ns ns
t _{d(off)}	Turn-off Delay Time Fall Time	$V_{DD}=30$ V, $I_{D}=2.5$ A R _G =4.7 Ω , $V_{GS}=4.5$ V (see Figure 12)		45 10		ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				5	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				20	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 5A, V_{GS} = 0$			1.2	٧
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 5A, V_{DD} = 40V$ di/dt = 100A/ μ s, $T_j = 150$ °C (see Figure 14)		85 85 2		ns nC A

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STS5NF60L

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

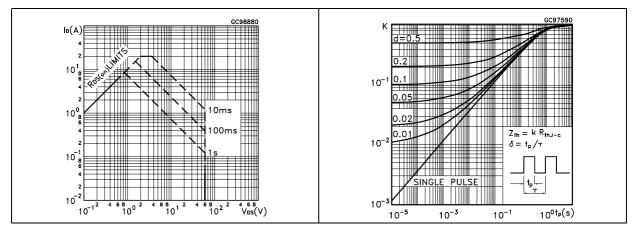


Figure 3. Output characteristics

Figure 4. Transfer characteristics

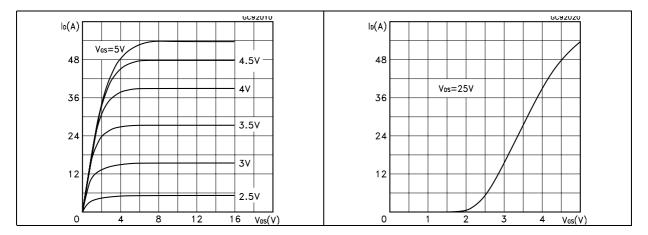


Figure 5. Transconductance

Figure 6. Static drain-source on resistance

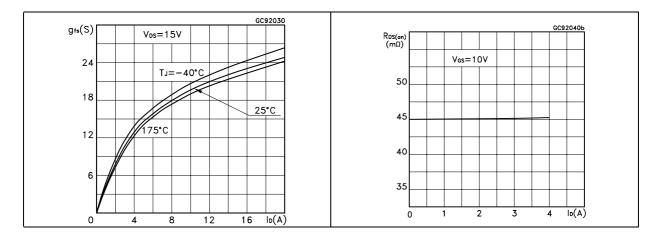


Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

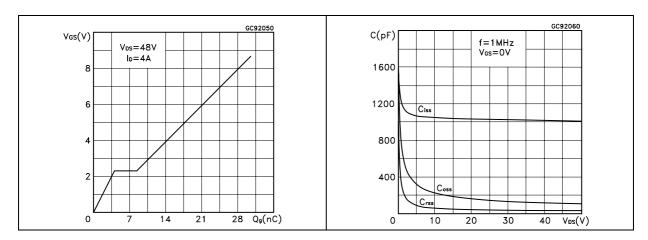


Figure 9. Normalized gate threshold voltage Figure 10. Normalized on resistance vs. vs. temperature temperature

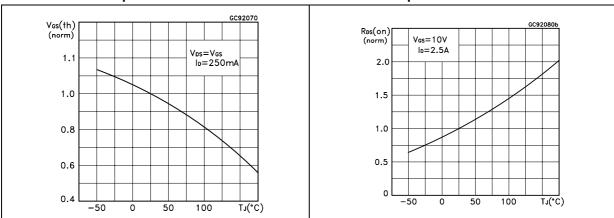
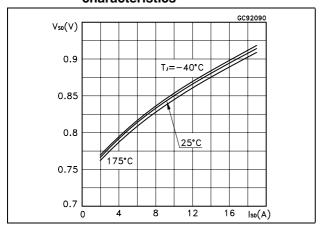


Figure 11. Source-drain diode forward characteristics



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Test circuit STS5NF60L

3 Test circuit

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

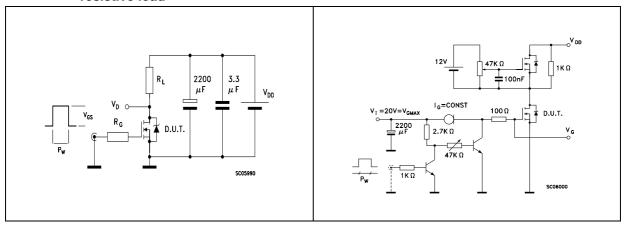


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped Inductive load test circuit

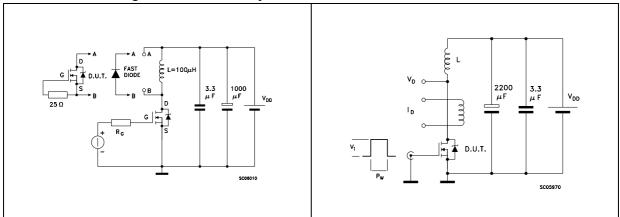
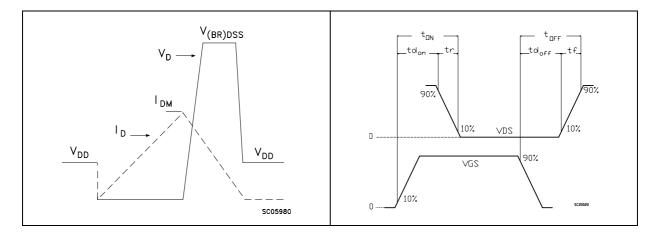


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform

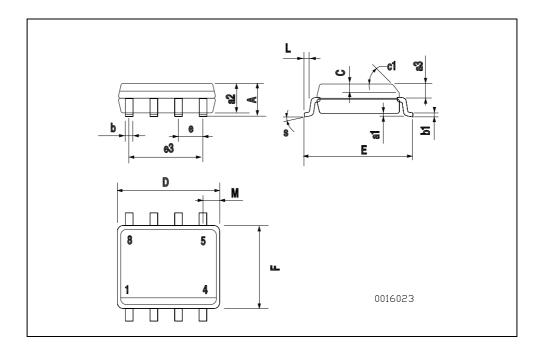


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

SO-8 MECHANICAL DATA

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
а3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45	(typ.)		
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S		•	8 (r	nax.)	•	•



STS5NF60L Revision history

5 Revision history

Table 7. Revision history

Date	Revision	Changes
21-Jun-2004	2	First release
06-Nov-2006	3	The document has been reformatted
30-Jan-2007	4	Typo mistake on Table 1.

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